

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1549	vaporiz\$5 with (liquid or coating) same heat\$3 with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:03
S2	1061	S1 and @ad<"20040218"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:03
S3	52	vaporiz\$5 with (liquid or coating) same heat\$3 with substrate with beam	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:04
S4	26	S3 and @ad<"20040218"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:04
S5	0	EP1723264	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:06
S6	7	"1723264"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:06
S7	2	"01723264"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:07
S8	369	explosive near vaporization	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:07
S9	290	S8 and @ad<"20040218"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:08

S10	55	iida near seiichiro.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:08
S11	82	tani near hisashi.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:08
S12	28	flanagan near aiden.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:09
S13	4	S12 and beam and vaporiz \$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:14
S14	80	talton.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:14
S15	21	talton near james.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:14
S16	6	S15 and laser	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:15
S17	5123	427/596,248.1.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:17
S18	936	427/596.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:17
S19	850	S18 and @ad<"20040218"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:18

S20	122	S19 and (coating or solution or liquid) same heat\$3 with substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:18
S21	37	S19 and transfer near heat \$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:18
S22	339	427/561.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:21
S23	265	S22 and @ad< "20040218"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:21
S24	190	S23 and (laser or electron)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:21
S25	114	S24 and (solution or liquid)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:42
S26	2	S24 and (solution or liquid) near target	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 11:50
S27	10	laser with heat\$3 with substrate with transfer with heat with target	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:08
S28	2	"5662762".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:13
S29	4	427/2.1-2.24.ccls. and laser near transfer	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:24

S30	3	"3978247".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:24
S31	626	427/2.1-2.24.cds. and beam	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:28
S32	91	427/2.1-2.24.cds. and beam with heat\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:28
S33	12	427/2.1-2.24.cds. and conducti\$3 with heat\$3 with transfer\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:37
S34	5	427/2.1-2.24.cds. and conduction with heat\$3 with transfer\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:38
S35	0	laser with substrate with target with conduction with heat\$3 with transfer \$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:39
S36	12	laser with substrate with target with heat\$3 with transfer\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:40
S37	1	laser near heat\$3 near substrate with substrate near heat\$3 near (solution or liquid or coating)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:42
S38	5	heat\$3 near substrate with substrate near transfer with heat\$3 near (solution or liquid or coating)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:43

S39	22	("20010011545"   "20030236323"   "20040118681"   "5091205"   "5968092"   "6025036"   "6048362"   "6177151"   "6419996"   "6440503"   "6766764"). PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:48
S40	2	"6440503".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 12:59
S41	3	("6440503").URPN.	USPAT	OR	OFF	2008/04/23 13:05
S42	17	("4752455"   "4987006"   "5258366"   "5389196"   "5643472"   "5773188"   "6440503").PN. OR ("6583381").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2008/04/23 13:05
S43	2	("5258366").URPN.	USPAT	OR	OFF	2008/04/23 13:07
S44	936	427/596.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 13:07
S45	266	S44 and transfer\$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 13:07
S46	240	S45 and @ad< "20040218"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 13:08
S47	4	S46 and medical near device	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT	OR	OFF	2008/04/23 13:08

4/23/2008 4:28:43 PM

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